# Schottky Power Rectifier, Switch Mode, 10 A, 35 V

# MBRD1035CTL, NRVBD1035VCTL, SBRD81035CTL Series

The MBRD1035CTL employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State of the art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies, free wheeling diode and polarity protection diodes.

## **Features**

- Highly Stable Oxide Passivated Junction
- Guardring for Stress Protection
- Matched Dual Die Construction –
   May be Paralleled for High Current Output
- High dv/dt Capability
- Short Heat Sink Tap Manufactured Not Sheared
- Very Low Forward Voltage Drop
- Epoxy Meets UL 94 V-0 @ 0.125 in
- SBRD8 and NRVBD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

## **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 0.4 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- ESD Rating:
  - Human Body Model = 3B (> 8 kV)
  - Machine Model = C (> 400 V)



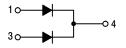
ON Semiconductor®

www.onsemi.com

# SCHOTTKY BARRIER RECTIFIER 10 AMPERES 35 VOLTS



DPAK CASE 369C



#### **MARKING DIAGRAM**



A = Assembly Location\*

Y = Year

WW = Work Week

B1035CL = Device Code

G = Pb-Free Package

\* The Assembly Location Code (A) is front side optional. In cases where the Assembly Location is stamped in the package bottom (molding ejecter pin), the front side assembly code may be blank.

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35	V
Average Rectified Forward Current (T <sub>C</sub> = 115°C) Per Leg Per Package	I <sub>O</sub>	5.0 10	А
Peak Repetitive Forward Current (Square Wave, Duty = 0.5, T <sub>C</sub> = 115°C) Per Leg	I <sub>FRM</sub>	10	А
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz) Per Package	I <sub>FSM</sub>	50	Α
Storage / Operating Case Temperature	T <sub>stg,</sub> T <sub>c</sub>	-55 to +150	°C
Operating Junction Temperature (Note 1)	T <sub>J</sub>	-55 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> , T <sub>J</sub> = 25°C)	dv/dt	10,000	V/µs

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

# THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case Per Leg	$R_{ hetaJC}$	3.0	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2) Per Leg	$R_{ hetaJA}$	137	°C/W

<sup>2.</sup> Rating applies when using minimum pad size, FR4 PC Board

# **ELECTRICAL CHARACTERISTICS**

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 3) (See Figure 2) Per Leq	V <sub>F</sub>		V
(I <sub>F</sub> = 5 Amps, T <sub>J</sub> = 25°C)		0.47	
(I <sub>F</sub> = 5 Amps, T <sub>J</sub> = 100°C)		0.41	
$(I_F = 10 \text{ Amps}, T_J = 25^{\circ}\text{C})$ $(I_F = 10 \text{ Amps}, T_J = 100^{\circ}\text{C})$		0.56 0.55	
Maximum Instantaneous Reverse Current (Note 3) (See Figure 4)	I <sub>R</sub>		mA
Per Leg (V <sub>B</sub> = 35 V, T <sub>J</sub> = 25°C)		2.0	
(V <sub>R</sub> = 35 V, T <sub>J</sub> = 100°C)		30	
$(V_R = 17.5 \text{ V}, T_J = 25^{\circ}\text{C})$		0.20	
(V <sub>R</sub> = 17.5 V, T <sub>J</sub> = 100°C)		5.0	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

<sup>1.</sup> The heat generated must be less than the thermal conductivity from Junction–to–Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

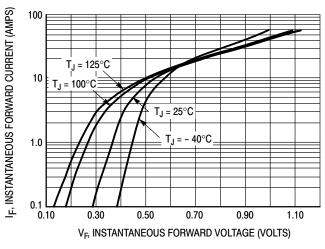
<sup>3.</sup> Pulse Test: Pulse Width ≤ 250 μs, Duty Cycle ≤ 2.0%

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBRD1035CTLG	DPAK (Pb-Free)	75 Units / Rail
SBRD81035CTLG*		75 Units / Rail
SBRD81035CTLG-VF01*		75 Units / Rail
MBRD1035CTLT4G		2,500 Units / Tape & Reel
NRVBD1035VCTLT4G*		2,500 Units / Tape & Reel
SBRD81035CTLT4G*		2,500 Units / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## **TYPICAL CHARACTERISTICS**



1.0 T<sub>J</sub> = 125°C

1.0 T<sub>J</sub> = 125°C

T<sub>J</sub> = 25°C

T<sub>J</sub> = 100°C

V<sub>E</sub> MAXIMUM INSTANTANEOUS FORWARD VOLTAGE (VOLTS)

Figure 1. Typical Forward Voltage Per Leg

Figure 2. Maximum Forward Voltage Per Leg

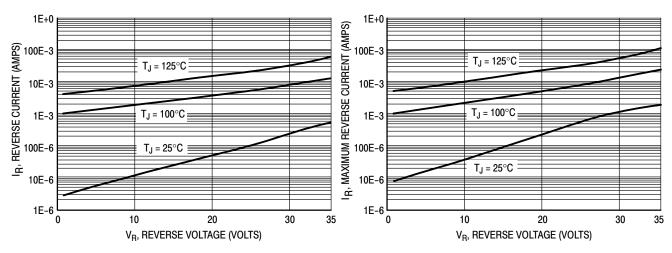


Figure 3. Typical Reverse Current Per Leg

Figure 4. Maximum Reverse Current Per Leg

<sup>\*</sup>SBRD8 and NRVBD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

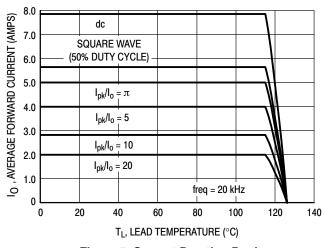


Figure 5. Current Derating Per Leg

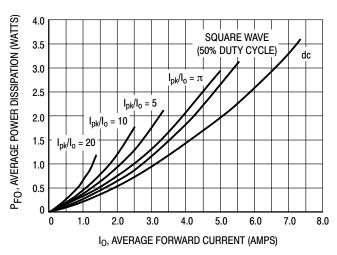


Figure 6. Forward Power Dissipation Per Leg

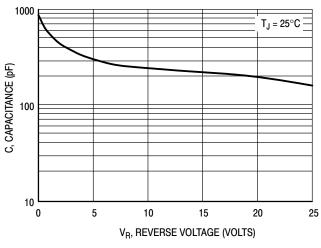


Figure 7. Capacitance Per Leg

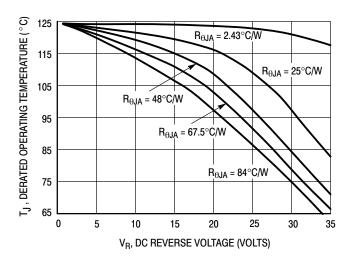


Figure 8. Typical Operating Temperature
Derating Per Leg \*

r(t) = thermal impedance under given conditions,

Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.

<sup>\*</sup> Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of  $T_J$  therefore must include forward and reverse power effects. The allowable operating  $T_J$  may be calculated from the equation:  $T_J = T_{Jmax} - r(t) (Pf + Pr)$  where

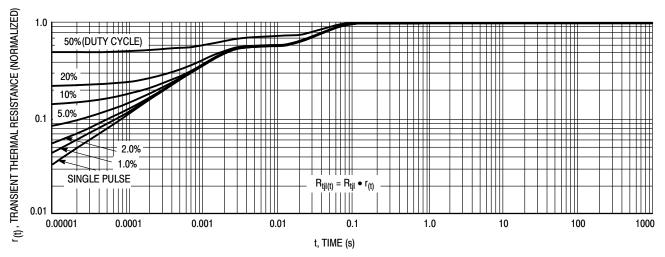


Figure 9. Thermal Response Junction to Case (Per Leg)

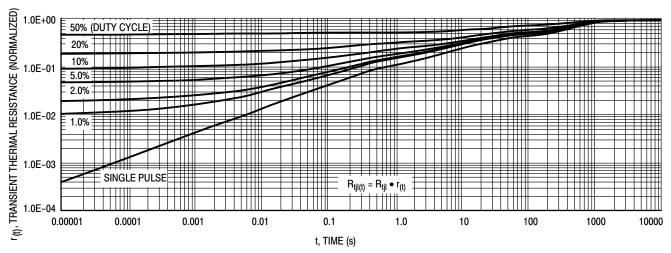
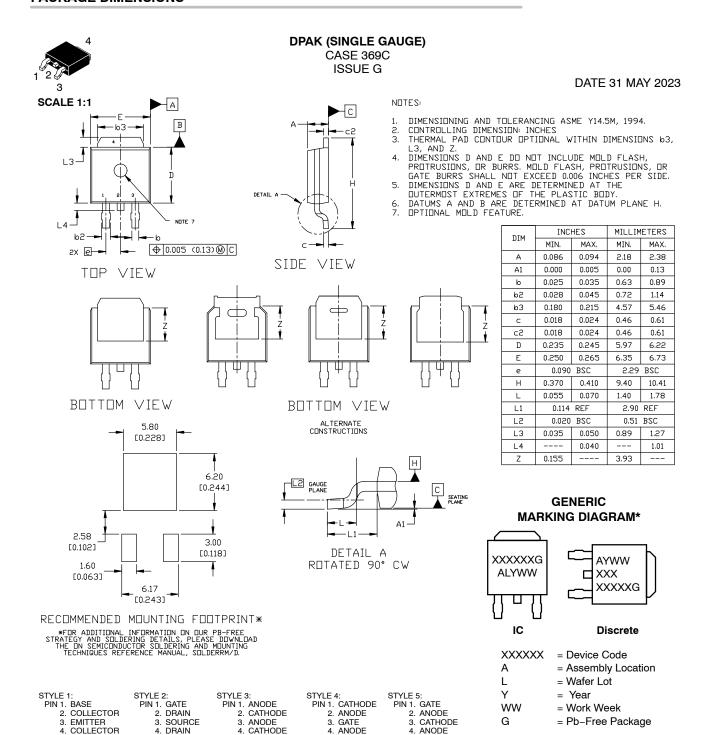


Figure 10. Thermal Response Junction to Ambient (Per Leg)





DOCUMENT NUMBER:	98AON10527D	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	DPAK (SINGLE GAUGE)		PAGE 1 OF 1

STYLE 10:

PIN 1. CATHODE 2. ANODE

3 CATHODE

4. ANODE

STYLE 9:

PIN 1. ANODE 2. CATHODE

3 RESISTOR ADJUST

CATHODE

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

STYLE 7: PIN 1. GATE 2. COLLECTOR

3 FMITTER

4. COLLECTOR

STYLE 8:

PIN 1. N/C 2. CATHODE

3 ANODE

CATHODE

STYLE 6:

PIN 1. MT1 2. MT2

3 GATE

\*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot "=", may

or may not be present. Some products may

not follow the Generic Marking.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

#### ADDITIONAL INFORMATION

**TECHNICAL PUBLICATIONS:** 

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$ 

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales